

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant: Leonard Forbes et al.

Title: STRAINED SEMICONDUCTOR BY FULL WAFER BONDING

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Filed: July 21, 2003
Examiner: Pamela Perkins
Customer No.: 73115

Serial No.: 10/623,788
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Confirmation No.: 6087

Notice of Allowance Date: June 27, 2008

Mail Stop Issue Fee

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

We are transmitting herewith the following:

- ☒ Authorization to charge Deposit 19-0743 in the amount of \$1440.00 to cover the Large Entity Issue Fee Payment
- ☒ Authorization to charge Deposit 19-0743 in the amount of \$300.00 to cover the Publication Fee Payment
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SCHWEGMAN, LUNDBERG & WOESSNER, P.A.

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Customer No.: 73115

Marvin L. Beekman

MLB:CMG:kerl

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CERTIFICATE UNDER 37 CFR 1.8: The undersigned hereby certifies that this correspondence is being filed using the USPTO's electronic filing system EFS-Web, and is addressed to: Mail Stop Issue Fee, Commissioner for Patents, P.O. Box 1450, Alexandria, VA 22313-1450 on this 17 day of September, 2008.

KATHLEEN E ROTHECK
Name

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Signature